

## **Customer Information Notification**

Issue Date: 22-Dec-2018
Effective Date: 23-Dec-2018

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# 2018090171



Change Category				
[] Wafer Fab Process	[] Assembly Process	[] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials		[] Mechanical Specification		[]Errata
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[] Wafer Fab Location	[] Assembly	[]	[] Test	[X] Electrical
	Location	Packing/Shipping/Labeling	Equipment	spec./Test coverage
[] Firmware	[] Other			· ·

MC9S12ZVL Family Reference Manual and Datasheet Update from Rev2.41 to Rev2.47

### **Description**

NXP Semiconductors announces a Reference Manual and Datasheet update for the MC9S12ZVL Family from revision 2.41 to revision 2.47.

All revisions are included in the CIN/updated document. The revision history included in the updated document provides a detailed description of the changes.

Main changes are summarized below.

- 1. Added version 2.1 of Chapter 1, "Device Overview MC9S12ZVL-Family"
- 2. Updated Appendix A, "MCU Electrical Specifications"
- VSUP max 28.5V for 1h over lifetime. Changed Section Table A-6, "Operating Conditions"
- Changed item 1 Table A-6 VSUP min 3.5V
- Added W Temperature Option to Appendix N, "Ordering Information"
- Added "Date Codes for fully trimmed ACLK Parts"
- 3. Updated Chapter 2, Port Integration Module 2.11
- 4. Other change detail please refer to Reference Manual and Datasheet revision history.

The MC9S12ZVL Family Reference Manual and Datasheet revision 2.47 is attached to this notice, and can be found at: https://www.nxp.com/products/processors-and-microcontrollers/additional-processors-and-mcus/8-16-bit-mcus/16-bit-s12-magniv/s12zvl-mixed-signal-mcu-for-automotive-industrial-lin-applications:S12ZVL?tab=Documentation\_Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02/SEM-DS-03

#### Reason

The Reference Manual and Datasheet has been updated to correct errors and / or provide additional technical clarification on some device features.

#### **Identification of Affected Products**

Product identification does not change

### Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

**Data Sheet Revision** 

A new datasheet will be issued

### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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### **Affected Part Numbers**

S9S12ZVL32F0MLF

S912ZVLA12F0MLF

S9S12ZVL32F0MLC

S9S12ZVLS3F0MFM

S9S12ZVL32F0VLF

S9S12ZVLS3F0CFM